PCN Num	ber:	201	5113000	00						PCN Date:	12/04/2015
Title:	Qualification of GTBF as Additional Assembly/Test Site for Select Devices										
Customer	Contact:	PCN /	<u>Manager</u>				Dept:			Quality Servi	ces
Proposed	1 st Ship Da	ite:	03/04/	201	6	Estimat Availab		nple			ate Provided at ample request
Change T	уре:										
Assem	nbly Site				De	esign				Wafer Bum	ıp Site
Assem		Data S		ita Sheet				Wafer Bum	p Material		
	nbly Material					Part number change			Wafer Bump Process		
	nical Specifi			\boxtimes		st Site				Wafer Fab	
Packir	ng/Shipping/	Labelin	g		Tes	st Process				Wafer Fab Materials	
										Wafer Fab	Process
					PC	N Detail	ls				
Description	on of Chang	je:									
Material di	fferences are	e as fol	lows.								sembly sites and
Assem	bly Site	Assen	nbly Site	te Origin		de	<u> </u>				
NFME			NFM	л CN				Nantong Jiangsu			
GTBF Ltd. GTF		GTF		CN			Sci. Park Phasell Shatin				
	Differences				Ni	FME				GTBF	
Mount Co	mpound				SID#	# A-05				EY000000)6
Mold Com				SID# R-07			EN000003				
Wire type					Au			Cu			
	Device (TO-	220):									
						FME				GTBF	
Mold Com				SID#R-12				EN0000038			
Mount Co	Mount Compound (Solder)			SID#A-11				SS00000	01		
Test coverage, insertions, conditions will remain consistent with current testing and verified with test MQ.											
Reason fo	or Change:										
Continuity	of Supply										
Anticipate	ed impact o	n Forn	n, Fit, F	unc	tion	n, Quality	or Rel	iabi	ity	(positive /	negative):
None											
Changes	Changes to product identification resulting from this PCN:										

Assembly Site		
NFME	Assembly Site Origin (22L)	ASO: NFM
GTBF (Great Team Backend Foundry)	Assembly Site Origin (22L)	ASO: GTF

Sample product shipping label (not actual product label)





(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483\$I2 (P) (2P) REV: (V) 0033317 (2DL) C\$0: SHE (21L) CCO: USA (22L) A\$0: MLA (23L) ACO: MYS

ASSEMBLY SITE CODES: NFME = E, GTBF = T

Group 1 Product Affected:

LM317KTTR	TL2575-ADJIKTTRG3	TL750L05CKTTRG3	TLV1117IKTTRG3
LM317KTTRG3	TL2575HV-05IKTTR	TL783CKTTR	UA7805CKTTR
TL2575-05IKTTR	TL2575HV-05IKTTRG3	TL783CKTTRG3	UA7805CKTTRG3
TL2575-05IKTTRG3	TL2575HV-33IKTTR	TLV1117CKTTR	UA7812CKTTR
TL2575-33IKTTR	TL2575HV-ADJIKTTR	TLV1117CKTTRG3	UA7812CKTTRG3
TL2575-ADJIKTTR	TL750L05CKTTR	TLV1117IKTTR	

Group 2 Product Affected:

CSD18502KCS	CSD18532KCS	CSD18542KCS	CSD19533KCS	
CSD18503KCS	CSD18533KCS	CSD19501KCS	CSD19534KCS	ì
CSD18504KCS	CSD18534KCS	CSD19503KCS	XCSD18542KCS	Ì
CSD18532DKCS	CSD18537NKCS	CSD19531KCS		Ì

Group 1: Qualification Report Qualify GTBF as Subcon A/T site for PWR Packages: Phase 1 Devices for KTT (3 and 5 pin)

Product Attributes

Attributes	Qual Device: LM317KTTR	Qual Device: TL2575-05IKTTR	Qual Device: TL750L05CKTTR
Assembly Site	GTBF	GTBF	GTBF
Package Family	TO-263 -KTT	TO-263 -KTT	TO-263 -KTT
Flammability Rating	UL 94 V-0	-	UL 94 V-0
Wafer Fab Supplier	SFAB	SFAB	SFAB
Wafer Process	JI1	Jl1	JI1

- QBS: Qual By Similarity
- Qual Devices qualified at LEVEL3-245C: TL2575-05IKTTR, LM317KTTR, TL750L05CKTTR

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: LM317KTTR	Qual Device: TL2575-05IKTTR	Qual Device: TL750L05CKTTR
AC	Autoclave 121C	96 Hours	3/231/0	1/77/0	3/231/0
CDM	ESD - CDM	1000 V	-	-	3/9/0
ED	Electrical Characterization	Per Datasheet Parameters	-	-	3/30/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	-	-
HTOL	Life Test, 125C	336 Hours	-	1/77/0	-
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/231/0	-	3/231/0
PD	Physical Dimensions		3/15/0	-	3/15/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	1/77/0	3/231/0
TS	Thermal Shock -65/150C	500 Cycles	-	-	3/231/0
WBP	Bond Pull	Wires	3/228/0	-	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	-	3/228/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

Group 2 Qualification Report A/T Site Qualification of GTBF using CSD18532KCS (TO-220) as Driver Vehicle

Product Attributes

Attributes	Qual Device: CSD18532KCS
Assembly Site	GTBF
Package Family	TO-220
Flammability Rating	UL-94V-0
Wafer Fab Supplier	CFAB
Wafer Fab Process	FET

⁻ QBS: Qual By Similarity

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: CSD18532KCS
IOL	Intermittent Operating Life	2min 'on'/ 2min 'off' for 10K cycles; 100°C Tj rise from 25°C to 125°C	3/231/0
PC	Convection Reflow	24hrs/125°C dry bake	3/900/0
PC	Convection Reflow	3x reflows/260°C +5°C/-0°C	3/900/0
AC	Autoclave 121°C	121°C, ~100%RH, 2Atm, 96hrs	3/231/0
TC	Temperature Cycle	-65°C/+150°C, 500 cycles	3/231/0
THB	Biased Temperature and Humidity	85°C/85%RH/80%Vds(max), 1000hrs	3/231/0
MQ	A/T Site Manufacturability	(per mfg. Site specification)	Pass

⁻ Preconditioning was performed prior to Autoclave, THB & Temperature Cycle, as applicable

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

or your rotal richa sales representatives				
Location	E-Mail			
USA	PCNAmericasContact@list.ti.com			
Europe	PCNEuropeContact@list.ti.com			
Asia Pacific	PCNAsiaContact@list.ti.com			
Japan	PCNJapanContact@list.ti.com			

⁻ Qual Device CSD18532KCS is qualified at Not Classified

⁻ The following are equivalent Temp Cycle options per JESD47: -55°C/125°C/700 Cycles and -65°C/150°C/500 Cycles Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/